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N-CHANNEL MOS FIELD EFFECT POWER TRANSISTOR 2SK1664

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK1664 is N-channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-state Resistance $R_{DS(on)} \leqq 6.0~\Omega \text{ (Vgs = 10 V, ID = 1 A)}$
- Low Ciss Ciss = 490 pF TYP.
- Built-in G-S Gate Protection Diode
- High Avalanche Capability Ratings

QUALITY GRADE

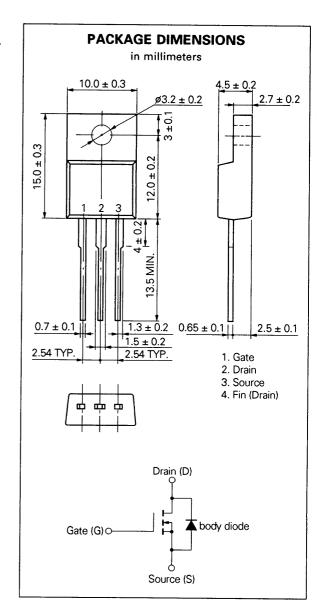
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS

Drain to Source Voltage	Voss	700	V
Gate to Source Voltage	Vgss	±30	٧
Drain Current (DC)	ID(DC)	±2.0	Α
Drain Current (pulse)	D(pulse)*	±8.0	Α
Total Power Dissipation (Tc = 25 °C)	PT ₁	30	W
Total Power Dissipation (Ta = 25 °C)	PT ₂	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current	las**	3.0	Α
Single Avalanche Energy	Eas**	28	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 2 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



90 %

90 %

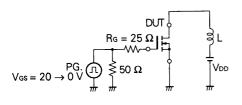
10%

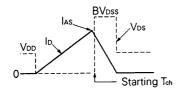
VGS (on)

ELECTRICAL CHARACTERISTICS ($T_a = 25$ °C)

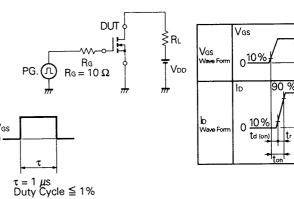
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	Rps(on)			6.0	Ω	Vgs = 10 V, lp = 1 A
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		4.0	v	Vos = 10 V, Io = 1 mA
Forward Transfer Admittance	Vfs	0.5			S	Vos = 10 V, ID = 1 A
Drain Leakage Current	loss			100	μΑ	V _{DS} = 700 V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±100	nA	V _G s = ±30 V, V _D s = 0
Input Capacitance	Ciss		490		pF	Vps = 10 V
Output Capacitance	Coss		140		pF	Vgs = 0
Reverse Transfer Capacitance	Сгвв		65		pF	f = 1 MHz
Turn-On Delay Time	td(on)		10		ns	V _{GS} = 10 V
Rise Time	tr		10		ns	V _{DD} = 150 V
Turn-Off Delay Time	td(off)		40		ns	lo = 1 A, Rg = 10 Ω
Fall Time	tr		10		ns	R _L = 150 Ω
Total Gate Charge	QG		17		nC	V _G s = 10 V
Gate to Source Charge	Qgs		3		nC	I _D = 2.0 A
Gate to Drain Charge	QGD		9		nC	V _{DD} = 450 V
Diode Forward Voltage	V _F (S-D)		1.0		٧	IF = 2.0 A, Vgs = 0
Reverse Recovery Time	trr		500		ns	IF = 2.0 A, Vgs = 0
Reverse Recovery Charge	Qrr		3.0		μC	di/dt = 50 A/μs

Test Circuit 1: Avalanche Capability

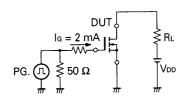




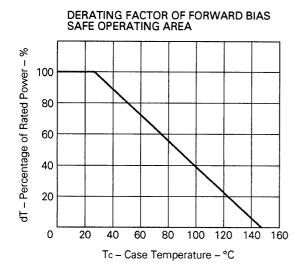
Test Circuit 2: Switching Time

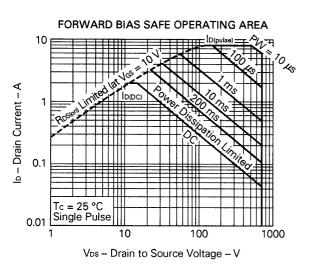


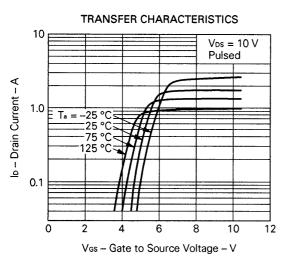
Test Circuit 3: Gate Charge

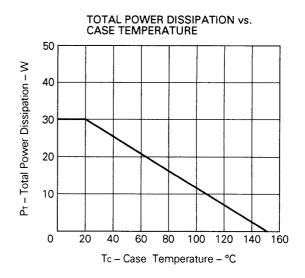


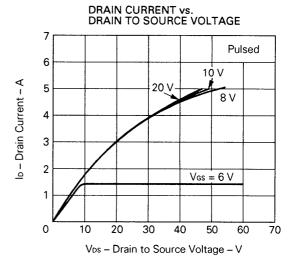
TYPICAL CHARACTERISTICS (Ta = 25 °C)

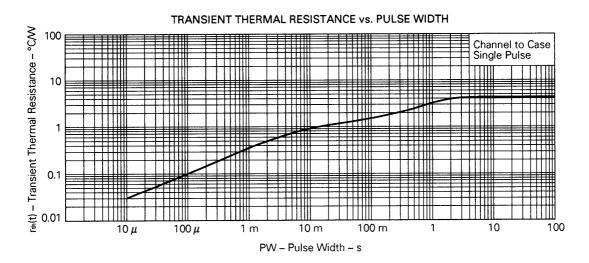


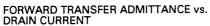


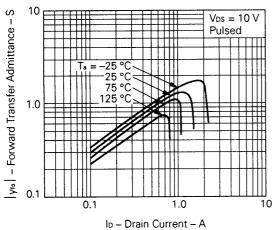




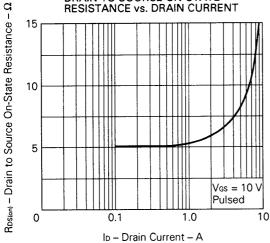




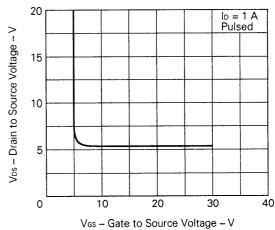




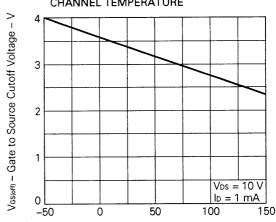
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



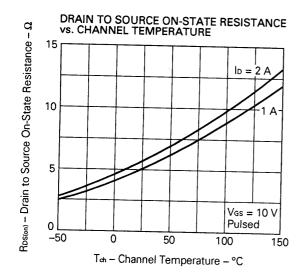
DRAIN TO SOURCE VOLTAGE vs. GATE TO SOURCE VOLTAGE

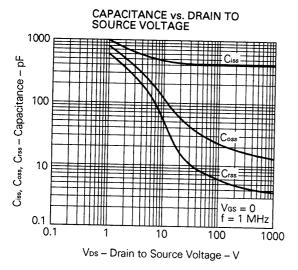


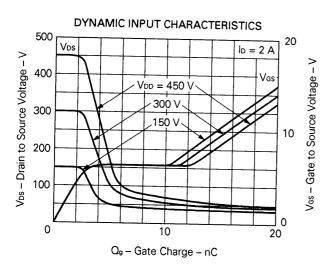
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

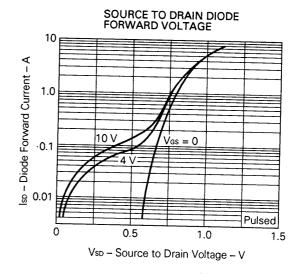


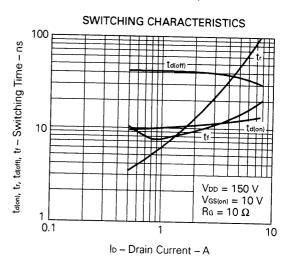
Tch - Channel Temperature - °C

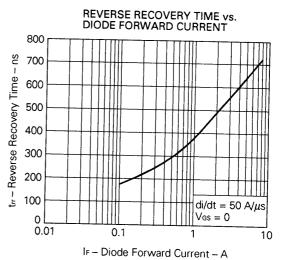




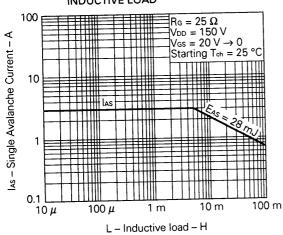




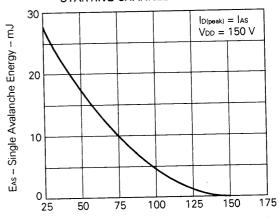




SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



Starting T_{oh} – Starting Channel Temperature – °C



Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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